TEMIC
Semiconductors

Low-Cost Time-Code Receiver

Description

The T4225B is a bipolar integrated straight-through receiver circuit in the frequency range of 40 kHz to 80 kHz. The device is designed for radio-controlled clock applications.

Features

- Very low power consumption
- Very high sensitivity
- High selectivity by using two crystal filters
- Power-down mode available
- Only a few external components necessary
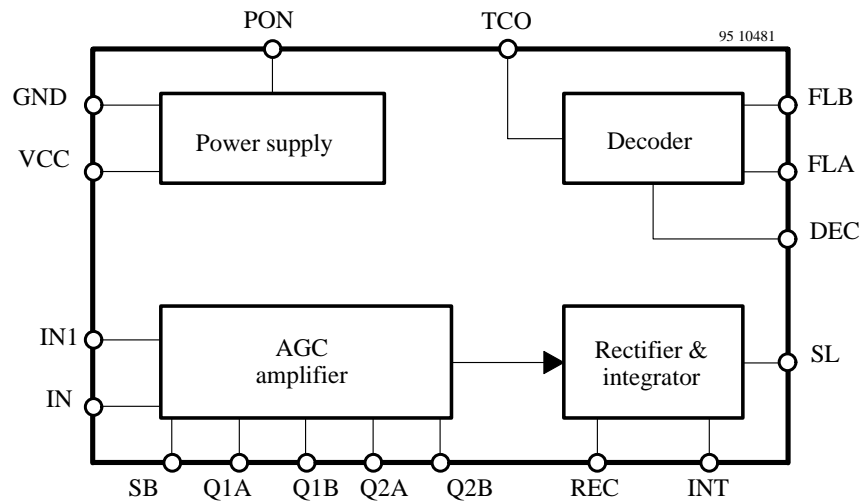- Digitalized serial output signal
- AGC hold mode

Block Diagram

Figure 1.

Ordering and Package Information

Extended Type Number	Package	Remarks
T4225B-MF	No	Die on foil
T4225B-MC	No	Die in tray
T4225B-MW	No	Wafer

PAD Coordinates

The T4225B is only available as die for "chip-on-board" mounting.

DIE size: 2.26 x 1.54 mm
PAD size: 100 x 100 μm (contact window 88 x 88 μm)
Thickness: 300 μm $\pm$ 20 μm

Symbol	Function	x-axis/μm	y-axis/μm
IN1	Amplifier input (inverted)	128	846
IN	Amplifier input (non inverted)	128	310
GND	Ground	354	124
SB	Bandwidth control	696	128
Q1A	Crystal filter 1	1040	128
Q1B	Crystal filter 1	1290	128
REC	Rectifier output	1528	128
INT	Integrator output	1766	128
DEC	Decoder input	2044	268
FLA	Lowpass filter	2044	676
FLB	Lowpass filter	2044	1072
SL	AGC hold mode	2044	1310
Q2A	Crystal filter 2	1724	1324
Q2B	Crystal filter 2	1402	1324
PON	Power-ON/OFF control	918	1324
TCO	Time-code output	460	1324
V_{CC}	Supply voltage	128	1246

The PAD coordinates are referred to the left bottom point
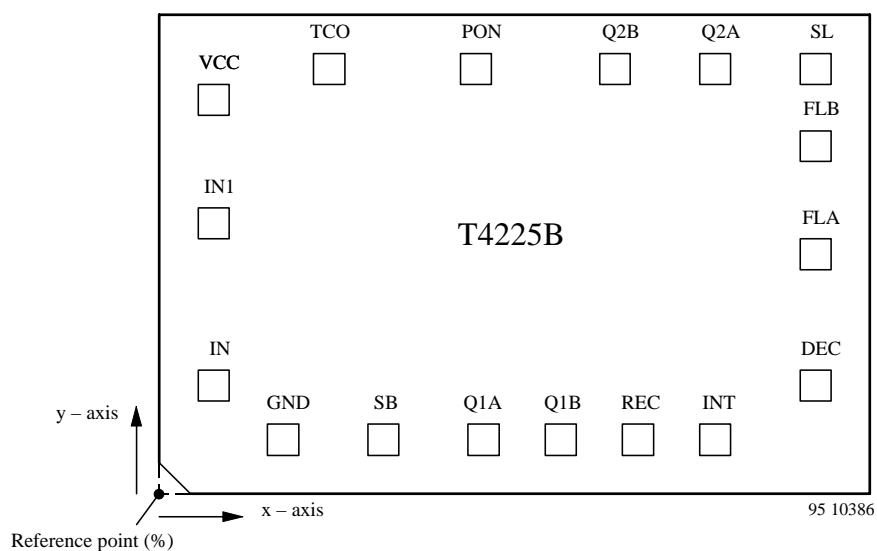of the contact window.
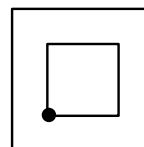
PAD Layout

Figure 2.

IN

A ferrite antenna is connected between IN and VCC. For high sensitivity, the Q factor of the antenna circuit should be as high as possible. Please note that a high Q factor requires temperature compensation of the resonant frequency in most cases. We recommend a Q factor between 50 and 100. Specifications are valid for $Q > 30$. An optimal signal-to-noise ratio will be achieved by a resonant resistance of 50 to 200 kΩ.
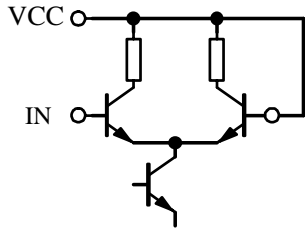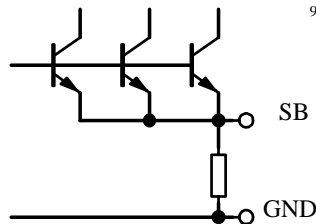

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Figure 3.

SB

A resistor R_{SB} is connected between SB and GND. It controls the bandwidth of the crystal filters. It is recommended: $R_{SB} = 0$ Ω for DCF 77.5 kHz, $R_{SB} = 10$ kΩ for 60 kHz WWVB and R_{SB} = open for JG2AS 40 kHz.
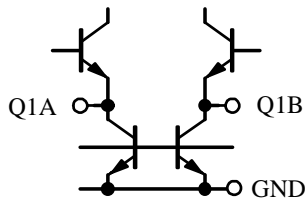

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Figure 4.

Q1A, Q1B

In order to achieve a high selectivity, a crystal is connected between the Pins Q1A and Q1B. It is used with the serial resonant frequency of the time-code transmitter (e.g., 60 kHz WWVB, 77.5 kHz DCF or 40 kHz JG2AS). The equivalent parallel capacitor of the filter crystal is internally compensated. The compensated value is about 0.7 pF. If full sensitivity and selectivity are not needed, the crystal filter can be substituted by a capacitor of 10 pF for DCF and WWVB and 22 pF for JG2AS.
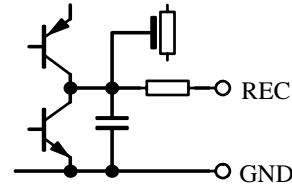

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Figure 5.

REC

Rectifier output and integrator input: The capacitor C_1 between REC and INT is the lowpass filter of the rectifier and at the same time a damping element of the gain control.
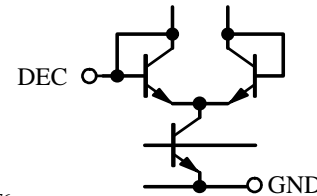

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Figure 6.

DEC

Decoder input: Senses the current through the integration capacitor C_2. The dynamic input resistance has a value of about 420 kΩ and is low compared to the impedance of C_2.
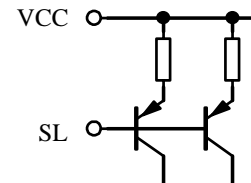

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Figure 7.

SL

AGC hold mode: SL high ($V_{SL} = V_{CC}$) sets normal function, SL low ($V_{SL} = 0$) disconnects the rectifier and holds the voltage V_{INT} at the integrator output and also the AGC amplifier gain.

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Figure 8.

INT

Integrator output: The voltage V_{INT} is the control voltage for the AGC. The capacitor C_2 between INT and DEC defines the time constant of the integrator. The current through the capacitor is the input signal of the decoder.
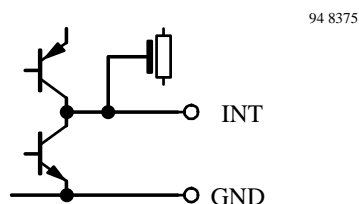
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Figure 9.

FLA, FLB

Lowpass filter: A capacitor C_3 connected between FLA and FLB suppresses higher frequencies at the trigger circuit of the decoder.
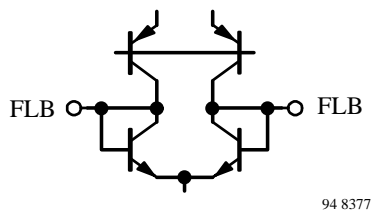

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Figure 10.

Q2A, Q2B

According to Q1A/Q1B, a crystal is connected between the Pins Q2A and Q2B. It is used with the serial resonant frequency of the time-code transmitter (e.g., 60 kHz WWVB, 77.5 kHz DCF or 40 kHz JG2AS). The equivalent parallel capacitor of the filter crystal is internally compensated. The value of the compensation is about 0.7 pF.
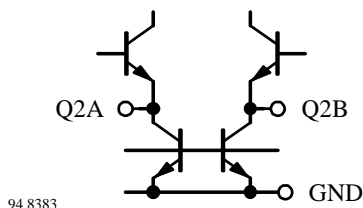

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Figure 11.

PON

If PON is connected to GND, the receiver will be activated. The set-up time is typically 0.5 s after applying GND at this pin. If PON is connected to V_{CC}, the receiver will switch to power-down mode.

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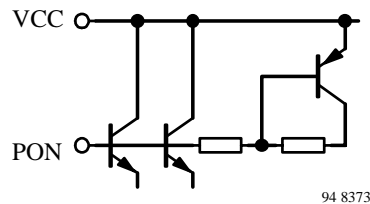
Figure 12.

TCO

The digitized serial signal of the time-code transmitter can be directly decoded by a microcomputer. Details about the time-code format of several transmitters are described separately.

The output consists of a PNP-NPN push-pull-stage. It should be taken into account that in power-down mode (PON = high), TCO will be high.

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Figure 13.

An additional improvement of the driving capability may be achieved by using a CMOS driver circuit or an NPN transistor with pull-up resistor connected to the collector (see figure 14). When using a CMOS driver, this circuit must be connected to VCC.

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Figure 14.

Please note:

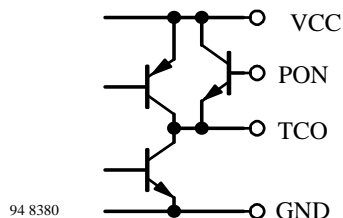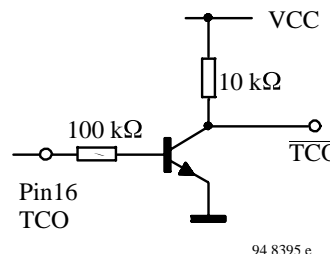The signals and voltages at the Pins REC, INT, FLA, FLB, Q1A, Q1B, Q2A and Q2B cannot be measured by standard measurement equipment due to very high internal impedances. For the same reason, the PCB should be protected against surface humidity.

Design Hints for the Ferrite Antenna

The bar antenna is a very critical device of the complete clock receiver. Observing some basic RF design rules helps to avoid possible problems. The IC requires a resonant resistance of 50 kΩ to 200 kΩ. This can be achieved by a variation of the L/C-relation in the antenna circuit. It is not easy to measure such high resistances in the RF region. A more convenient way is to distinguish between the different bandwidths of the antenna circuit and to calculate the resonant resistance afterwards.

Thus, the first step in designing the antenna circuit is to measure the bandwidth. Figure 16 shows an example for the test circuit. The RF signal is coupled into the bar antenna by inductive means, e.g., a wire loop. It can be measured by a simple oscilloscope using the 10:1 probe. The input capacitance of the probe, typically about 10 pF, should be taken into consideration. By varying the frequency of the signal generator, the resonant frequency can be determined.
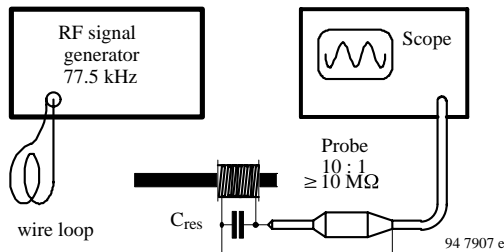

Figure 15.

At the point where the voltage of the RF signal at the probe drops by 3 dB, the two frequencies can then be measured. The difference between these two frequencies is called the bandwidth BW_A of the antenna circuit. As the value of the capacitor C_{res} in the antenna circuit is known, it is easy to compute the resonant resistance according to the following formula:

$$R_{res} = \frac{1}{2 \times \pi \times BW_A \times C_{res}}$$

where
R_{res} is the resonant resistance,
BW_A is the measured bandwidth (in Hz)
C_{res} is the value of the capacitor in the antenna circuit (in Farad).

If high inductance values and low capacitor values are used, the additional parasitic capacitances of the coil (≤ 20 pF) must be considered. The Q value of the capacitor should be no problem if a high Q type is used. The Q value of the coil differs more or less from the DC resistance of the wire. Skin effects can be observed but do not dominate.

Therefore, it should not be a problem to achieve the recommended values of the resonant resistance. The use of thicker wire increases the Q value and accordingly reduces bandwidth. This is advantageous in order to improve reception in noisy areas. On the other hand, temperature compensation of the resonant frequency might become a problem if the bandwidth of the antenna circuit is low compared to the temperature variation of the resonant frequency. Of course, the Q value can also be reduced by a parallel resistor.

Temperature compensation of the resonant frequency is a must if the clock is used at different temperatures. Please ask your supplier of bar antenna material and of capacitors for specified values of the temperature coefficient.

Furthermore, some critical parasitics have to be considered. These are shortened loops (e.g., in the ground line of the PCB board) close to the antenna and undesired loops in the antenna circuit. Shortened loops decrease the Q value of the circuit. They have the same effect like conducting plates close to the antenna. To avoid undesired loops in the antenna circuit, it is recommended to mount the capacitor C_{res} as close as possible to the antenna coil or to use a twisted wire for the antenna-coil connection. This twisted line is also necessary to reduce feedback of noise from the microprocessor to the IC input. Long connection lines must be shielded.

A final adjustment of the time-code receiver can be carried out by pushing the coil along the bar antenna. The maximum of the integrator output voltage V_{INT} at Pin INT indicates the resonant point. But attention: The load current should not exceed 1 nA, that means an input resistance ≥ 1 GΩ of the measuring device is required. Therefore, a special DVM or an isolation amplifier is necessary.

Absolute Maximum Ratings

Parameters	Symbol	Value	Unit
Supply voltage	V_{CC}	5.25	V
Ambient temperature range	T_{amb}	–40 to +85	°C
Storage temperature range	R_{stg}	–40 to +85	°C
Junction temperature	T_j	125	°C
Electrostatic handling (MIL Standard 883 D), except Pad IN, Q1A, Q1B, Q2A, Q2B	$\pm V_{ESD}$	2000	V

Electrical Characteristics

$V_{CC} = 3$ V, reference point Pin 3, input signal frequency 80 kHz, $T_{amb} = 25$°C, unless otherwise specified

Parameters	Test Conditions / Pin	Symbol	Min.	Typ.	Max.	Unit
Supply voltage range	Pad V_{CC}	V_{CC}	1.2		5.25	V
Supply current Without reception signal with reception signal = 200 μV OFF mode	Pad V_{CC}	I_{CC}		 15	25 20 0.1	 μA μA μA
Set-up time after V_{CC} ON	$V_{CC} = 1.5$ V	t		2		s
AGC amplifier input; IN	**Pad IN**					
Reception frequency range		f_{in}	40		80	kHz
Minimum input voltage	$R_{res} = 100$ kΩ, $Q_{res} > 30$	V_{in}		1	1.5	μV
Maximum input voltage		V_{in}	40	80		mV
Input capacitance to ground		C_{in}		1.5		pF
Time code output; TCO	**Pad TCO**					

Output voltage
  HIGH
  LOW
	$R_{LOAD} = 870$ kΩ to GND
	$R_{LOAD} = 650$ kΩ to V_{CC}
		V_{OH}
		V_{OL}
			V_{CC}-0.4		
					0.4
						V
						V

Output current
  HIGH
  LOW
	$V_{TCO} = V_{CC}/2$
	$V_{TCO} = V_{CC}/2$
		I_{SOURCE}
		I_{SINK}
			3
			4
				10
				12
						μA
						μA

Decoding characteristics for typical fieldstrentgh 1 mV/m	DCF77 based on the values of the application circuit fig. 20: TCO pulse width 100 ms TCO pulse width 200 ms Delay compared with the transient of the RF signal: drop down (start transition) rise for 100 ms pulse (end transition) rise for 200 ms pulse (end transition)	 t_{100} t_{200} t_s t_{e1} t_{e2}	 60 160 30 25 10	 90 190	 130 230 60 55 30	 ms ms ms ms ms

Parameters	Test Conditions / Pin	Symbol	Min.	Typ.	Max.	Unit
Decoding characteristics for typical fieldstrentgh 1 mV/m	WWVBbased on the values of the application circuit fig. 21:					
	TCO pulse width 200 ms	t_{200}	140		200	ms
	TCO pulse width 500 ms	t_{500}	440		500	ms
	TCO pulse width 800 ms	t_{800}	740		800	ms
	Delay compared with the transient of the RF signal:					
	drop down (start transition)	t_s	45		80	ms
	rise (end transition)	t_e	20		45	ms
	JG2AS based on the values of the application circuit fig. 22:					
	TCO pulse width 200 ms	t_{200}	240		410	ms
	TCO pulse width 500 ms	t_{500}	420		490	ms
	TCO pulse width 800 ms	t_{800}	720		790	ms
	Delay compared with the transient of the RF signal:					
	start transition (RF on)	t_s	10		110	ms
	end transition (RF off)	t_e	30		220	ms
Power- ON/OFF control; PON Pad PON						
Input voltage HIGH LOW	Required $I_{IN} \geqq 0.5$ µA		V_{CC}-0.2		V_{CC}-1.2	V V
Input current	$V_{CC} = 3$ V $V_{CC} = 1.5$ V $V_{CC} = 5$ V	I_{IN}	1.4	1.7 0.7 3	2	µA µA µA
Set-up time after PON		t		0.5	2	s
AGC hold mode; SL Pad SL						
Input voltage HIGH LOW	Required $I_{IN} \geqq 0.5$ µA		V_{CC}-0.2		V_{CC}-1.2	V V
Input current	$V_{in} = V_{CC}$ $V_{in} = GND$			2.5	0.1	µA µA
Rejection of interference signals	$\mid f_d - f_{ud} \mid$ = 625 Hz $V_d = 3$ µV, $f_d = 77.5$ kHz using 2 crystal filters using 1 crystal filter	a_f a_f		43 22		dB dB

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Test Circuit (for Fundamental Function)
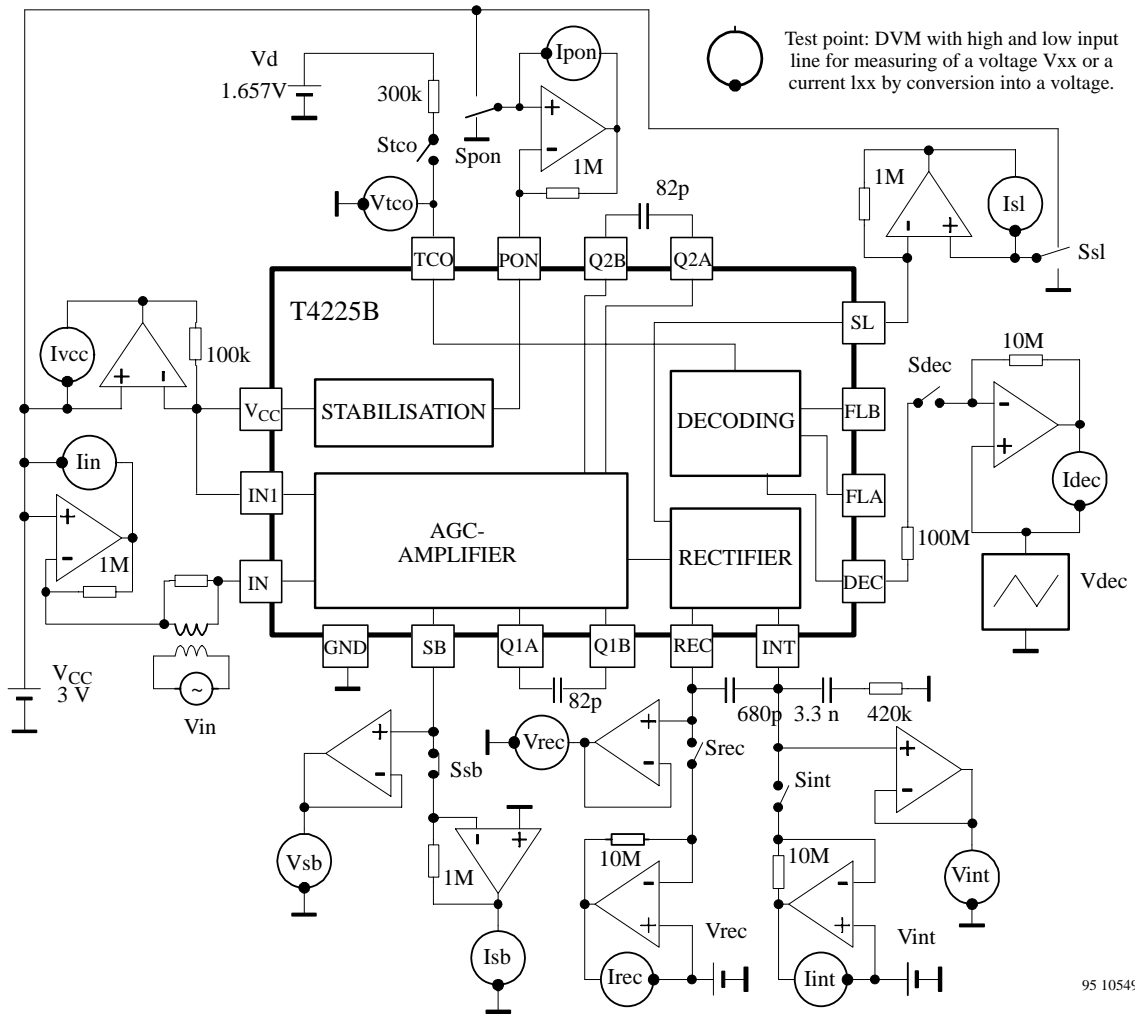

Figure 16.

Figure 17 shows a typical diagram to control sensitivity by measuring the voltage at INT vs. Vi$_n$. The input signal (e.g., generator frequency 77.5 kHz) is coupled to the input of the circuit via a transformer with a 50-Ω termination. In order to avoid a load at the INT Pin, the voltage should be measured with a meter input resistance > 1 GΩ!

(1)   normal curve
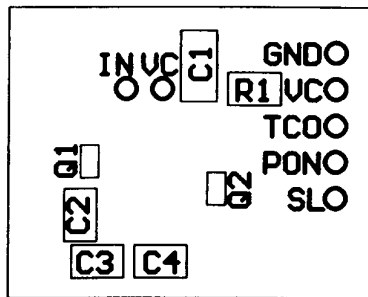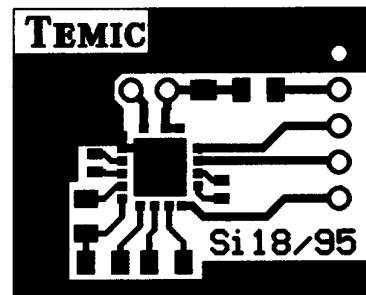(2)   no optimal layout conditions

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Figure 17.

Ra = Rb = 50 Ω
La = Lb = 88 μH

95 11208
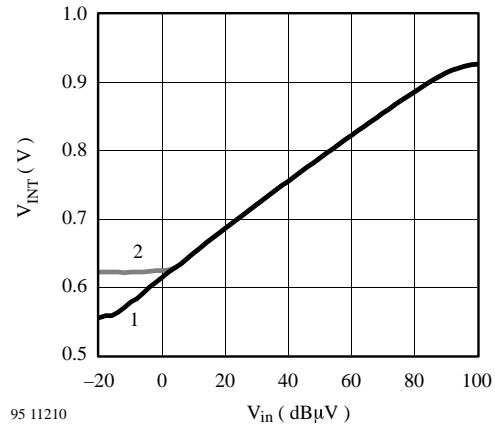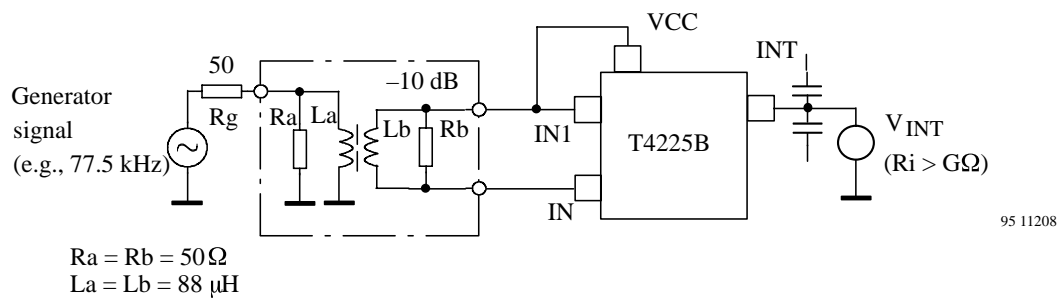
Figure 18.

Layout

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Figure 19.

T4225B

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Application Circuit for DCF 77.5 kHz
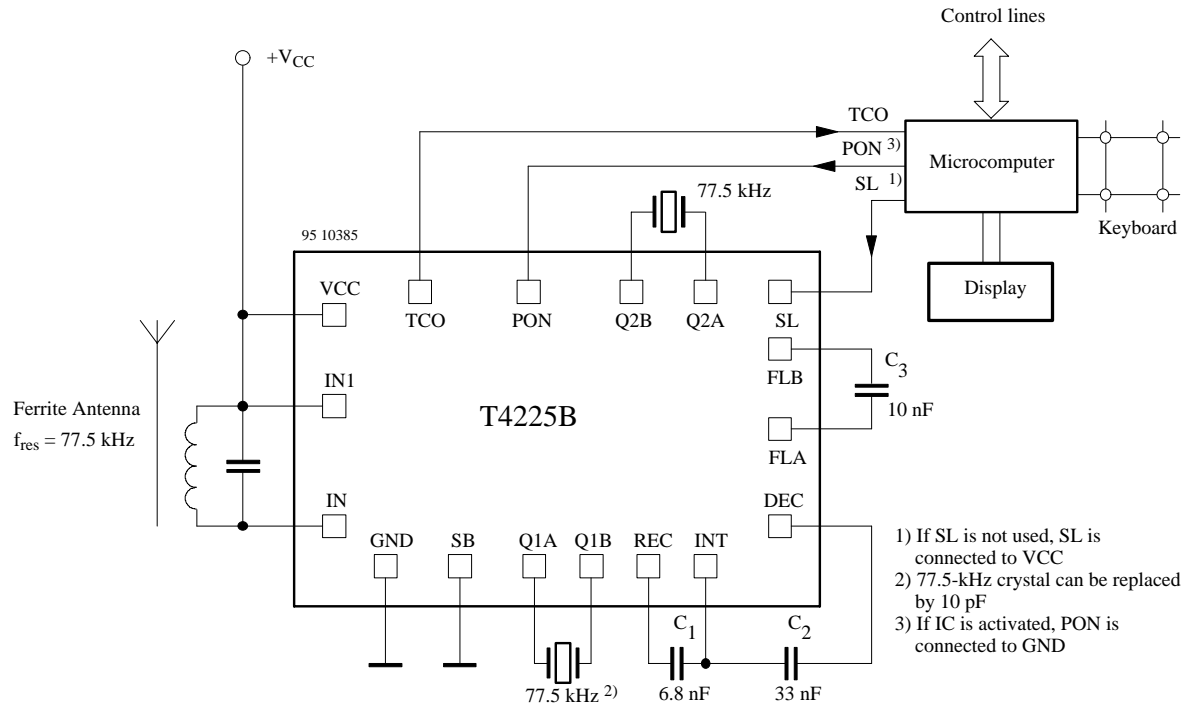
Figure 20.

Application Circuit for WWVB 60 kHz

Figure 21.

Rev. A3, 03-Dec-98
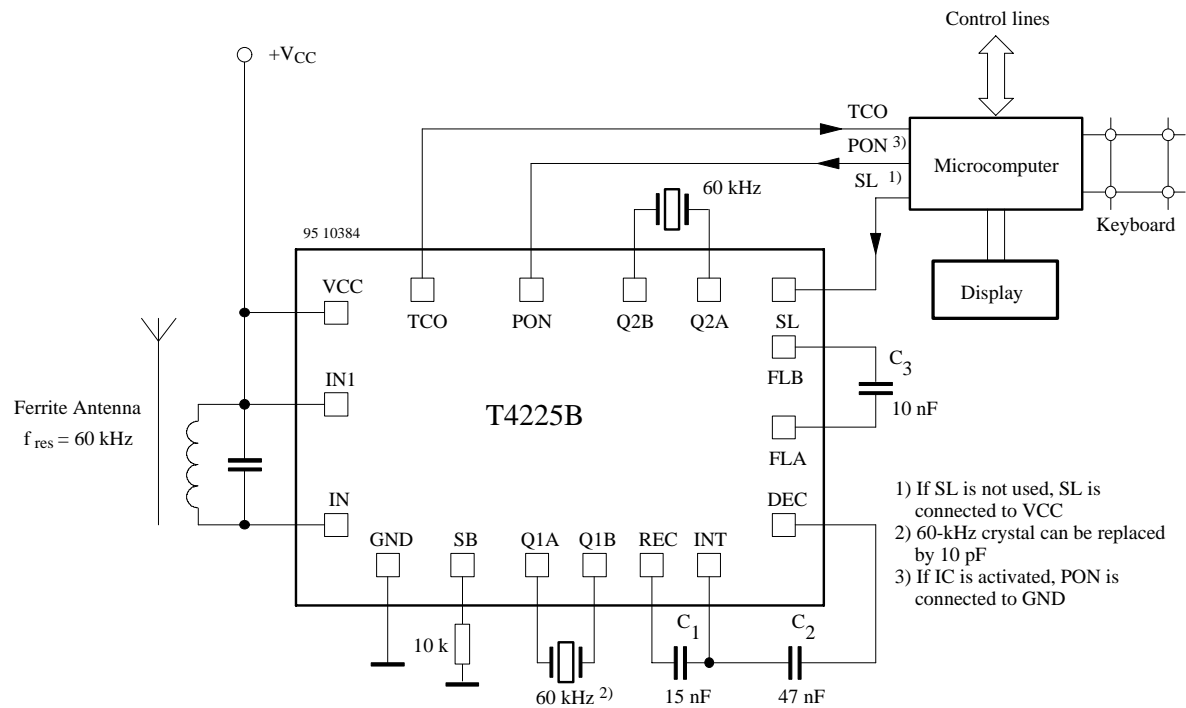
Application Circuit for JG2AS 40 kHz

Figure 22.

1) If SL is not used, SL is connected to VCC
2) 40-kHz crystal can be replaced by 22 pF
3) If IC is activated, PON is connected to GND

T4225B
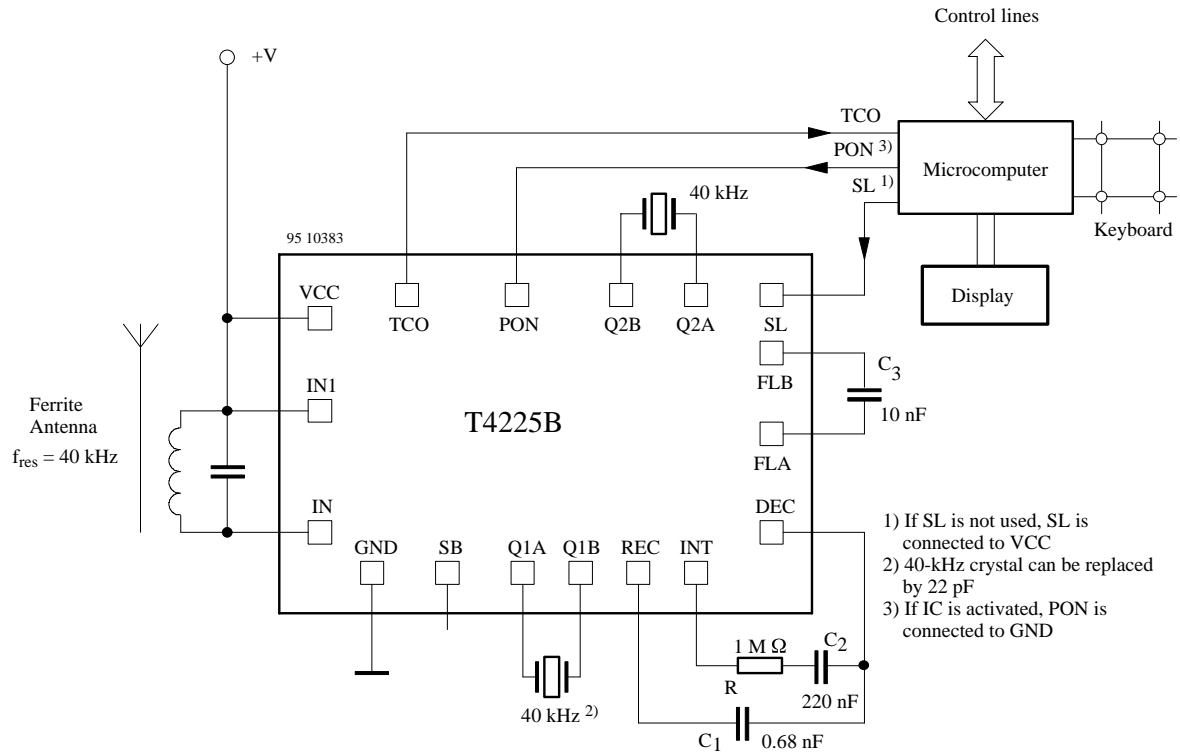
Information on the German Transmitter

Station: DCF 77,
Frequency 77.5 kHz,
Transmitting power 50 kW

Location: Mainflingen/Germany,
Geographical coordinates: 50°° 0.1'N, 09°° 00'E
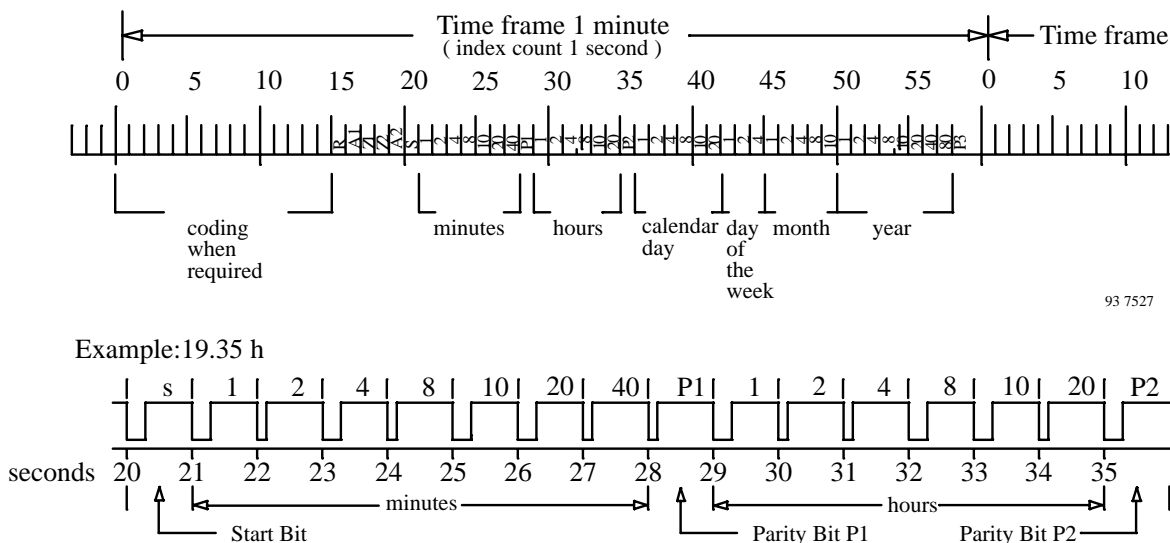Time of transmission: permanent

Figure 23.

Modulation

The carrier amplitude is reduced to 25% at the beginning of each second for a period of 100 ms (binary zero) or 200 ms (binary one), except the 59th second.

Time-Code Format: (based on Information of Deutsche Bundespost)

The time-code format consists of 1-minute time frames. There is no modulation at the beginning of the 59th second to indicate the switch over to the next 1-minute time frame. A time frame contains BCD-coded information of minutes, hours, calendar day, day of the week, month and year between the 20th second and 58th second of the time frame, including the start bit S (200 ms) and parity bits P1, P2 and P3. Furthermore, there are 5 additional bits R (transmission by reserve antenna), A1 (announcement of change-over to summer time), Z1 (during summer time 200 ms, otherwise 100 ms), Z2 (during standard time 200 ms, otherwise 100 ms) and A2 (announcement of leap second) transmitted between the 15th second and 19th second of the time frame.

Information on the British Transmitter

Station: MSF
Frequency 60 kHz
Transmitting power 50 kW
Location: Teddington, Middlesex

Geographical coordinates: 52°° 22'N, 01° 11'W
Time of transmission: permanent, except the first Tuesday of each month from 10.00 h to 14.00 h.
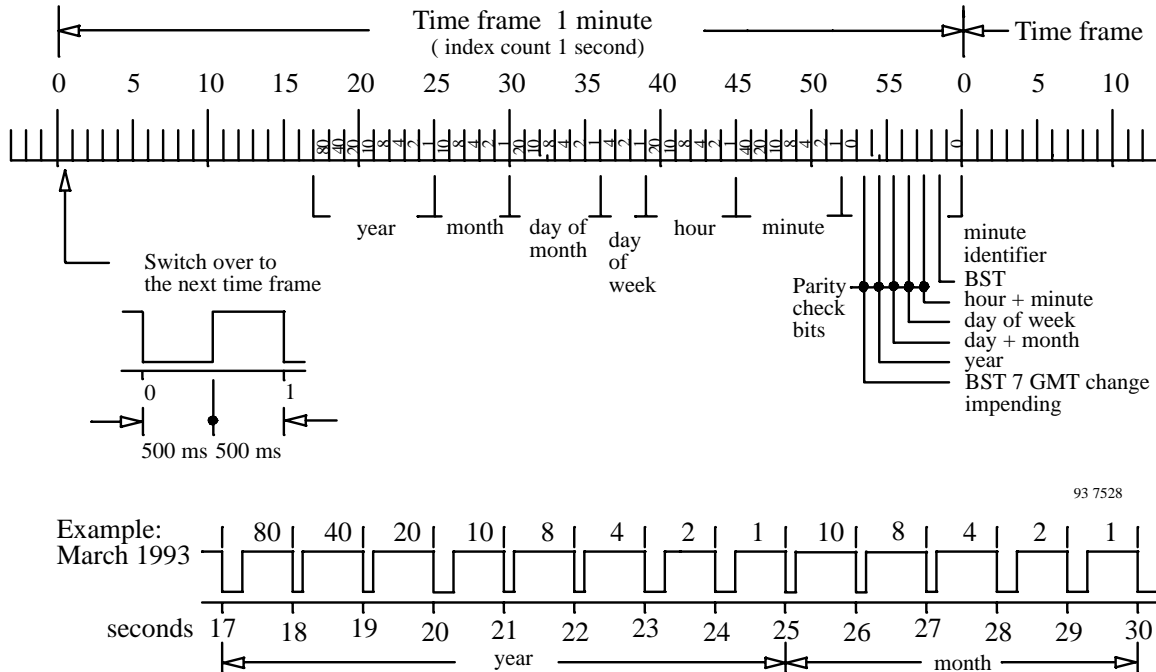

Figure 24.

Modulation

The carrier amplitude is switched off at the beginning of each second for a period of 100 ms (binary zero) or 200 ms (binary one).
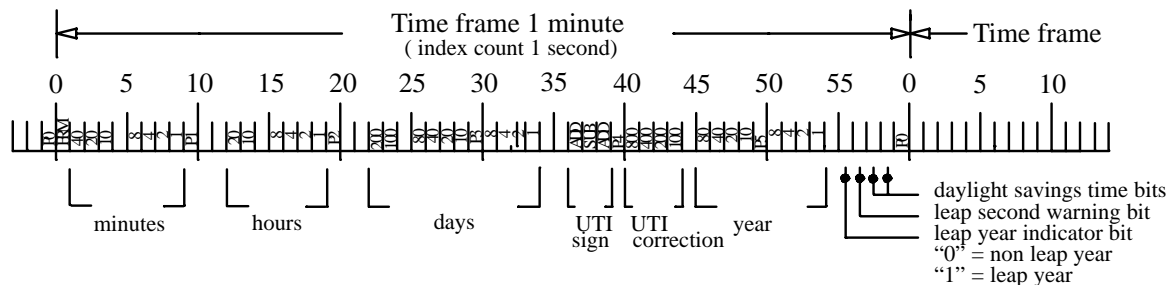
Time-Code Format

The time-code format consists of 1-minute time frames. A time frame contains BCD-coded information of year, month, calendar day, day of the week, hours and minutes. At the switch-over to the next time frame, the carrier amplitude is switched off for a period of 500 ms.

The prescence of the fast code during the first 500 ms at the beginning of the minute is not guaranteed. The transmission rate is 100 bits/s and the code contains information of hour, minute, day and month.

Information on the US Transmitter

Station: WWVB
Frequency 60 kHz
Transmitting power 40 kW

Location: Fort Collins
Geographical coordinates: 40° 40'N, 105° 03'W
Time of transmission: permanent

Time frame 1 minute
(index count 1 second)

Time frame

0   5   10   15   20   25   30   35   40   45   50   55   0   5   10

minutes   hours   days   UTI sign UTI correction year

daylight savings time bits
leap second warning bit
leap year indicator bit
"0" = non leap year
"1" = leap year

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Example: UTC 18.42 h

Time frame

P0   40 20 10   8 4 2 1 P1   20 10   8 4 2 1 P2

seconds 0   1   2   3   4   5   6   7   8   9   10   11   12   13   14   15   16   17   18   19   20

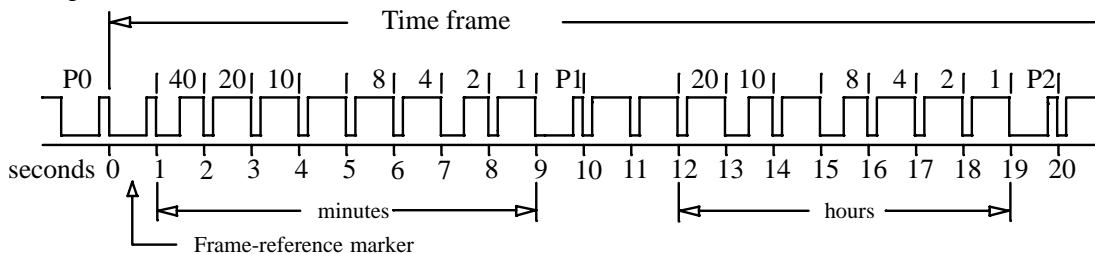minutes   hours

Frame-reference marker

Figure 25.

Modulation

The carrier amplitude is reduced by 10 dB at the beginning of each second and is restored within 500 ms (binary one) or within 200 ms (binary zero).

Time-Code Format

The time-code format consists of 1-minute time frames. A time frame contains BCD-coded information of minutes, hours, days and year. In addition, there are 6 position-identifier markers (P0 thru P5) and 1 frame-reference marker with reduced carrier amplitude of 800 ms duration.

Information on the Japanese Transmitter

Station: JG2AS
Frequency 40 kHz
Transmitting power 10 kW

Location: Sanwa, Ibaraki
Geographical coordinates: 36° 11' N, 139° 51' E
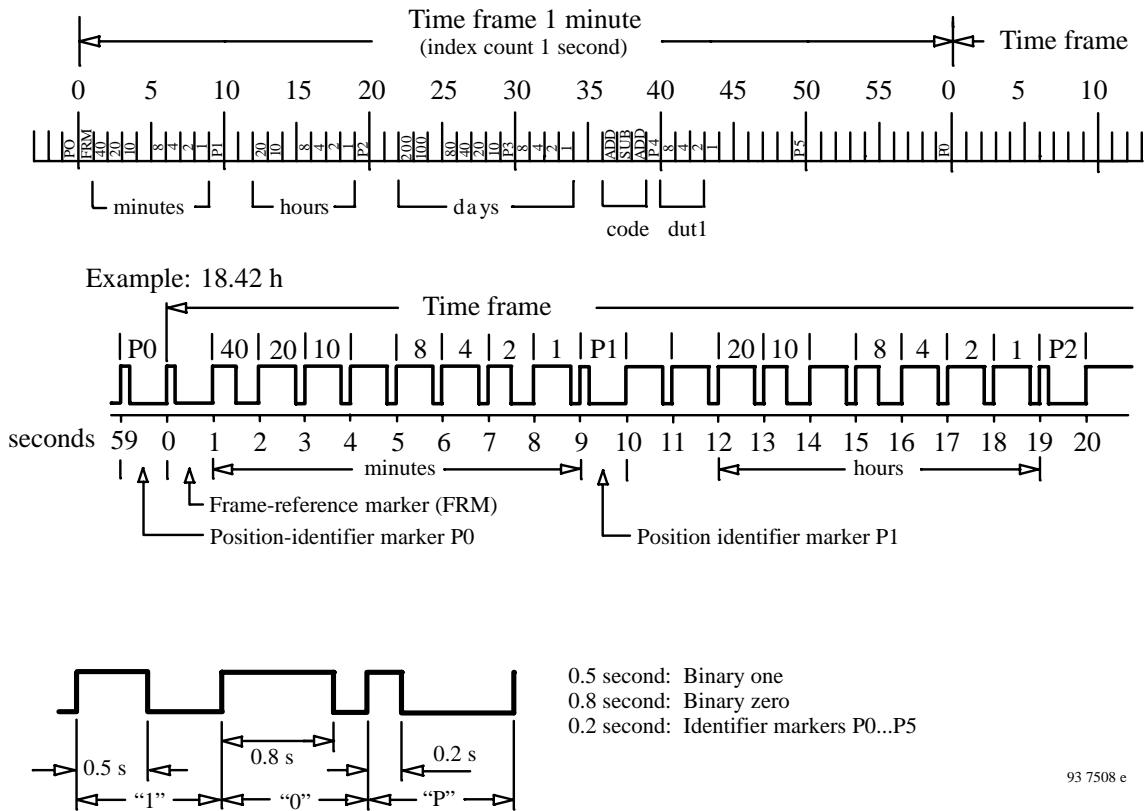Time of transmission: permanent

Figure 26.

Modulation

The carrier amplitude is 100% at the beginning of each second and is switched off after 500 ms (binary one) or after 800 ms (binary zero).

Time-Code Format

The time-code format consists of 1-minute time frames. A time frame contains BCD-coded information of minutes, hours and days. In addition, there are 6 position-identifier markers (P0 thru P5) and 1 frame-reference marker (FRM) with reduced carrier amplitude of 800 ms duration.

T4225B

T E M I C
S e m i c o n d u c t o r s

Ozone Depleting Substances Policy Statement

It is the policy of **TEMIC Semiconductor GmbH** to

1. Meet all present and future national and international statutory requirements.

2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

TEMIC Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively

2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA

3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

TEMIC Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.